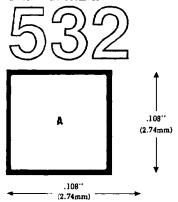
MEDIUM VOLTAGE, FAST RECOVERY

CHIP NUMBER



CONTACT METALLIZATION

Anode: > 50,000 Å Aluminum

Cathode: Gold

(Polished silicon or "Chrome Nickel Silver" also available)

PN EPITAXIAL FAST RECOVERY PLANAR POWER DIODE

Also available on:

MOLY PEDESTAL

.140" Diameter (3.56mm)

Thickness:

.010" (0.25mm)

BeO PEDESTAL

Size:

.142" x .178" (3.61mm x 4.52mm)

Thickness:

.028" (0.71mm)

ASSEMBLY RECOMMENDATIONS

It is advisable that:

- a) the chip be eutectically mounted with gold silicon preform 98/2%.
- b) 12 mil (0.305mm) aluminum wire be ultrasonically attached to the anode contact.

Anode:

1.086" x 1.086" (2.18mm x 2.18mm)

TYPICAL ELECTRICAL CHARACTERISTICS AT 25°C

The following typical electrical characteristics apply for a completely finished component employing the chip number 532 in a DO-4 or equivalent case:

Minimum VR @ 10 µA	V _F @	Ι _F	IF Surge	Maximum $t_{rr} @ I_F = I_R = 1.0 \text{Å}$ $I_{REC} = 0.25 \text{Å}$
> 50V	1.3V	10 A	>200A	75 ns
> 80V	1.3 V	10 A	>200A	75 ns
>1000	1.3 V	10A	>200A	75 ns
>400 V	1.8 V	10A	>100 A	75 ns
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